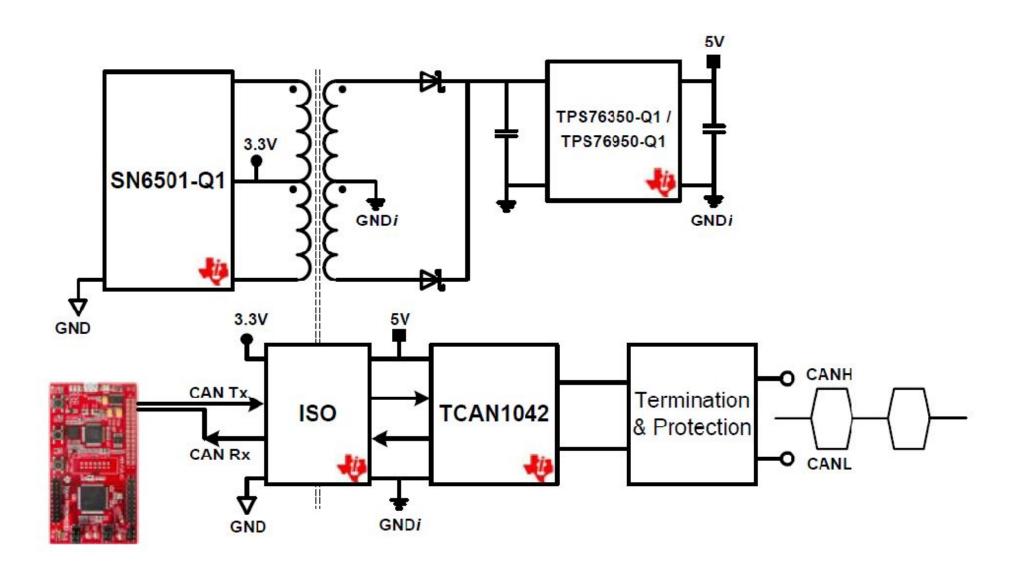
5 Revision History ECN# Rev Approved Date Approved by Notes N/A N/A N/A



Mod. Date: 4/17/2017

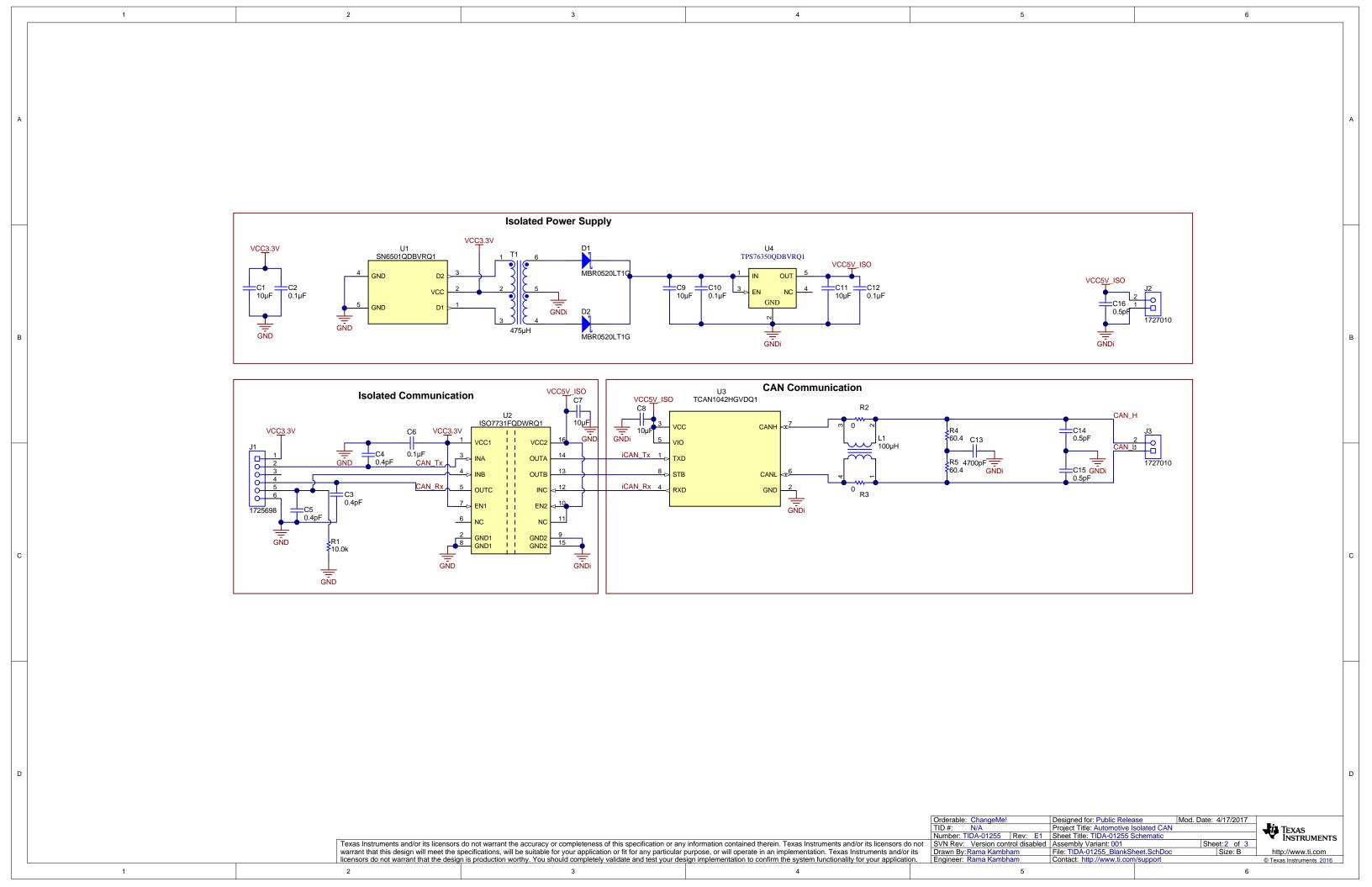
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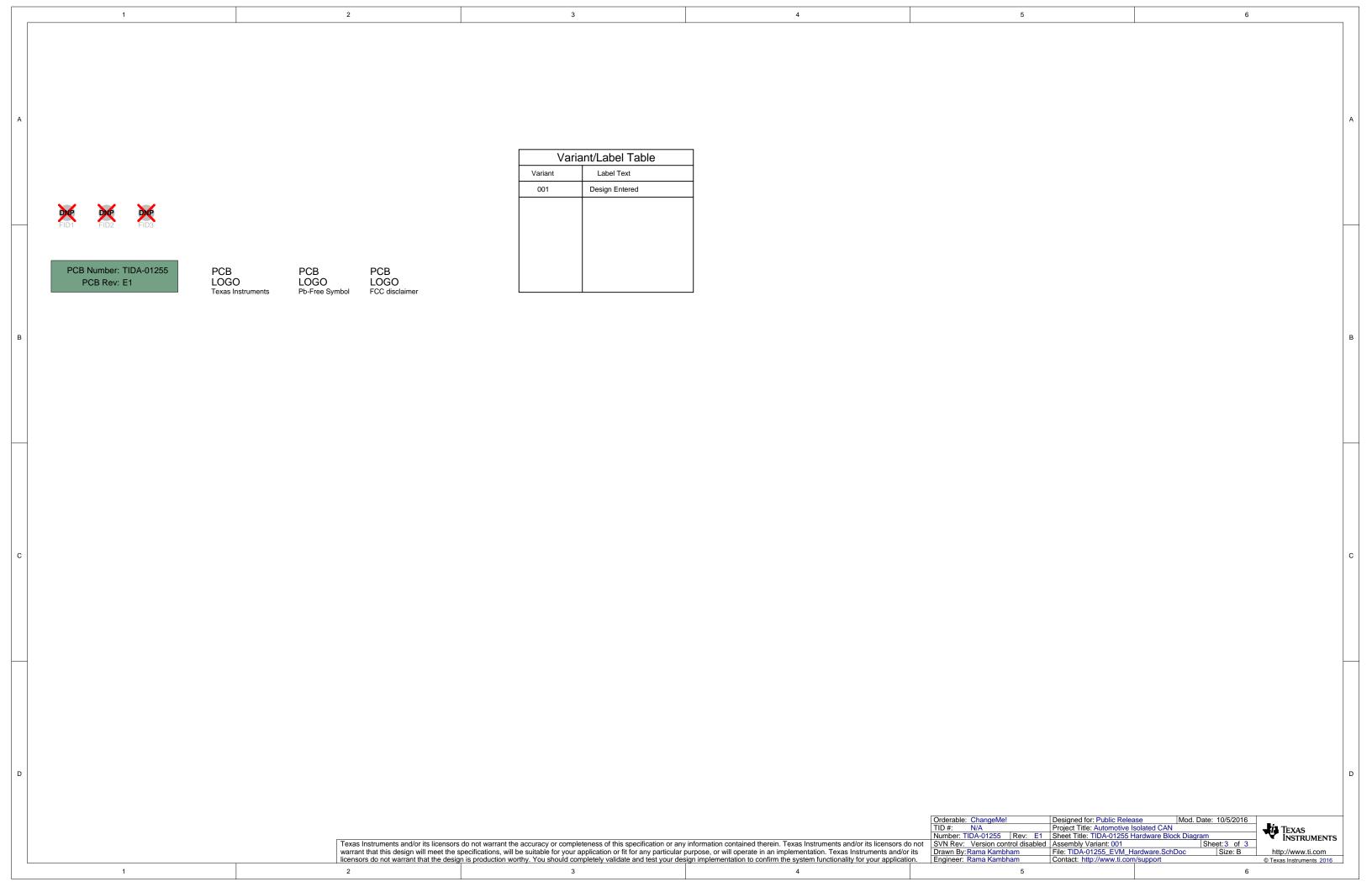
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Toderable: ChangeMe! Project Title: Automotive Isolated CAN Number: TIDA-01255 Rev: E1 Sheet Title: TIDA-01255 Block Diagram SVN Rev: Version control disabled Assembly Variant: 001 Drawn By: Rama Kambham File: TIDA-01255 CoverSheet.SchDoc Engineer: Rama Kambham Contact: http://www.ti.com/support

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